

Single-Stage Power Factor Corrected Off-Line Switching Regulator IC

Features and Benefits

- Integrated on-width control circuit (it realizes high power factor by average current control)
- Integrated startup circuit (no external startup circuit necessary)
- Integrated soft-start circuit (reduces power stress during start-up on the incorporated power MOSFET and output diode)
- Integrated bias assist circuit (improves the startup performance, suppresses V_{CC} voltage droop during operation, allows reduction of VCC capacitor value as well as use of a ceramic capacitor)
- Integrated Leading Edge Blanking (LEB) circuit
- Integrated maximum on-time limit circuit
- Dual-chip structure, with an avalanche-guaranteed power MOSFET (allows simplified surge suppressing circuits)
- Protection features:
- ^o Overcurrent protection (OCP): pulse-by-pulse
- Overvoltage protection (OVP): pins VCC, OVP, and OCP, intermittent oscillation operation
- Overload protection (OLP): intermittent oscillation operation
- Thermal shutdown (TSD): halts switching operation and latches in the off-state

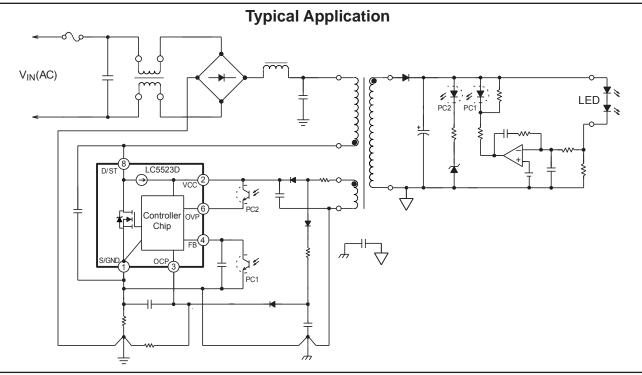
Package: 8-pin DIP



Description

The LC5500 series is a quasi-resonant topology switching power supply IC, designed for input capacitorless applications, and making it possible for systems to comply with the harmonics standard (IEC61000-3-2 class C). It incorporates separate controller and power MOSFET chips. The controller adapts the average current control method for realizing high power factors, and the quasi-resonant topology contributes to high efficiency and low EMI noise. The rich set of protection features helps to realize low component counts, and high performance-to-cost power supply.

The LC5523D is intended for isolated designs. The incorporated MOSFET has a $V_{DSS}(min)$ rating of 650 V and $R_{DS(on)}(max)$ of 1.9 Ω . It is capable of a maximum output power of 20 W on 230 VAC supply and 16 W on universal supply based on the thermal rating. Note that the maximum output power can be up to 120% to 140% of this value. However, it may be limited in applications with low output voltage or short duty cycle.



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Selection Guide

Part Number	Package	Packing
LC5523D	DIP8 with pin 7 removed	50 pieces per tube

Absolute Maximum Ratings T_A = 25°C, unless otherwise specified

Characteristic	Symbol	Notes	Pins	Rating	Unit
Drain Current ¹	I _{DPeak}	Single pulse	8 – 1	4.0	A
Single Pulse Avalanche Energy ²	E _{AS}	I _{LPeak} = 2.7 A, V _{DD} = 99 V, L = 20 mH	8 – 1	86	mJ
Input Voltage in Control Part	V _{CC}		2 – 1	35	V
OCP Terminal Voltage	V _{OCP}		3 – 1	-2.0 to 5.0	V
FB Terminal Voltage	V _{FB}		4 – 1	-0.3 to 7.0	V
OVP Terminal Voltage	V _{OVP}		6 – 1	-0.3 to 5.0	V
Power Dissipation in MOSFET ³	P _{D1}	When embedding this hybrid IC onto the printed circuit board (board size 15 mm ×15 mm)	8 – 1	0.97	W
Operating Ambient Temperature	T _{OP}		—	-55 to 125	°C
Storage Temperature	T _{stg}		_	-55 to 125	°C
Channel Temperature	T _{ch}		—	150	°C

¹Refer to MOSFET Safe Operating Area Curve.

²Refer to MOSFET Avalanche Energy Derating Coefficient Curve.

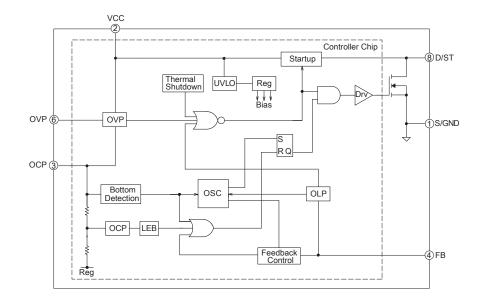
³Refer to MOSFET Temperature versus Power Dissipation Curve.





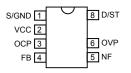
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Functional Block Diagram



LC5523D Terminal List Table

Pin-out Diagram



Number	Name	Function
1	S/GND	MOSFET source and GND terminal for the Controller chip
2	VCC	Supply voltage input
3	OCP	Overcurrent protection and quasi-resonant signal input terminal
4	FB	Feedback signal input and Overload protection (OLP) signal input
5	NF	No function; must be externally connected to S/GND pin with as short a trace as possible, for stable operation of the device
6	OVP	Overvoltage protection (OVP) signal input
7	_	Pin removed
8	D/ST	MOSFET drain terminal and input of the startup current





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ELECTRICAL CHARACTERISTICS (Control Part)¹ T_A = 25°C, V_{CC} = 20 V, unless otherwise specified

Characteristics	Symbol	Test Conditions	Pins	Min.	Тур.	Max.	Unit
Power Supply Start-up Operation							
Operation Start Voltage	V _{CC(ON)}		2 – 1	13.8	15.1	17.3	V
Operation Stop Voltage ²	V _{CC(OFF)}		2 – 1	8.4	9.4	10.7	V
Circuit Current in Operation	I _{CC(ON)}		2 – 1	-	-	3.7	mA
Startup Circuit Operation Voltage	VSTARTUP		8 – 1	42	57	72	V
Startup Current	I _{CC(STARTUP)}	V _{D/ST} = 100 V, V _{CC} = 13 V	2 – 1	-5.5	-3.0	-1.0	mA
Startup Current Supplying Threshold Voltage-1 ²	V _{CC(BIAS)1}	V _{D/ST} = 100 V	2 – 1	9.5	11.0	12.5	V
Startup Current Supplying Threshold Voltage-2	V _{CC(BIAS)2}	V _{D/ST} = 100 V	2 – 1	14.4	16.6	18.8	V
Normal Operation							
Oscillation Minimum Frequency	f _{OSC}		8 – 1	11.0	14.0	18.0	kHz
Maximum On Time	t _{ON(MAX)}		8 – 1	30.0	40.0	50.0	μs
FB Terminal Minimum Voltage in Feedback Operation	V _{FB(MIN)}		4 – 1	0.55	0.90	1.25	V
Maximum Feedback Current	I _{FB(MAX)}		4 – 1	-10	-25	-40	μA
Leading Edge Blanking Time	t _{BW}		3 – 1	-	500	-	ns
Quasi-Resonant Operation Threshold Voltage-1	V _{BD(TH1)}		3 – 1	0.14	0.24	0.34	V
Quasi-Resonant Operation Threshold Voltage-2	V _{BD(TH2)}		3 – 1	0.12	0.17	0.22	V
Protection Operation			·				
Over-Current Detection Threshold Voltage	V _{OCP}		3 – 1	-0.54	-0.60	-0.66	V
OCP Terminal Source Current	I _{OCP}		3 – 1	-120	-40	-10	μA
OVP Operation Voltage of OCP Terminal	V _{OCP(OVP)}		3 – 1	2.2	2.6	3.0	V
OLP Threshold Voltage	V _{FB(OLP)1}		4 – 1	5.0	5.5	6.0	V
OLP Threshold Voltage	V _{FB(OLP)2}		4 – 1	4.1	4.5	4.9	V
OVP Terminal Threshold Voltage	V _{OVP(TH)}		6 – 1	1.6	2.0	2.4	V
OVP Operation Voltage of VCC Terminal	V _{CC(OVP)}		2 – 1	28.5	31.5	34.0	V
Thermal Shutdown Operating Temperature	T _{J(TSD)}		-	135	-	_	°C

¹The current ratings are based on those of the IC, and plus (+) represents sink and minus (-) represents source. ²The relation $V_{CC(BIAS)1} > V_{CC(OFF)}$ is applied for each product.





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ELECTRICAL CHARACTERISTICS (MOSFET) T_A = 25°C, V_{CC} = 20 V, unless otherwise specified

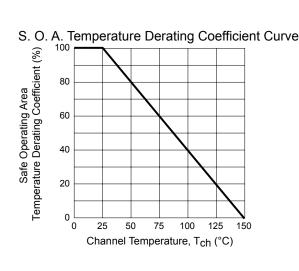
Characteristics	Symbol	Test Conditions	Pins	Min.	Тур.	Max.	Unit
Drain-to-Source Breakdown Voltage	V _{DSS}	I _{DSS} = 300 μA	8 – 1	650	—	—	V
Drain Leakage Current	I _{DSS}	V _{DSS} = 650 V	8 – 1	—	—	300	μA
Circuit Current in Operation	R _{DS(on)}	I _{DS} = 0.4 A	8 – 1	—	—	1.9	Ω
Switching Time	tr		8 – 1	—	—	400	ns
Thermal Resistance	$R_{ extsf{ heta}ch-c}$	Between channel and case; case temperature, T_{C} , measured at the center of the marking side	_	_	_	35.5	°C/W



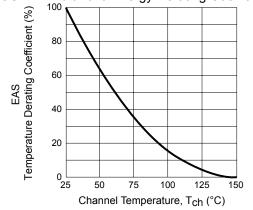


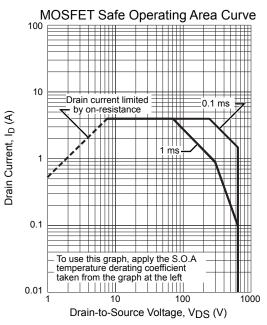
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Characteristic Performance

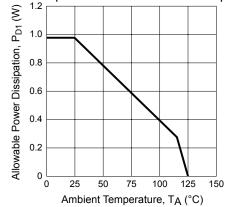


MOSFET Avalanche Energy Derating Coefficient Curve

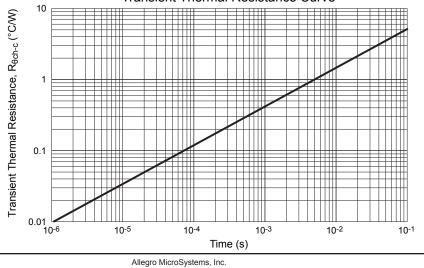




MOSFET Temperature versus Power Dissipation Curve



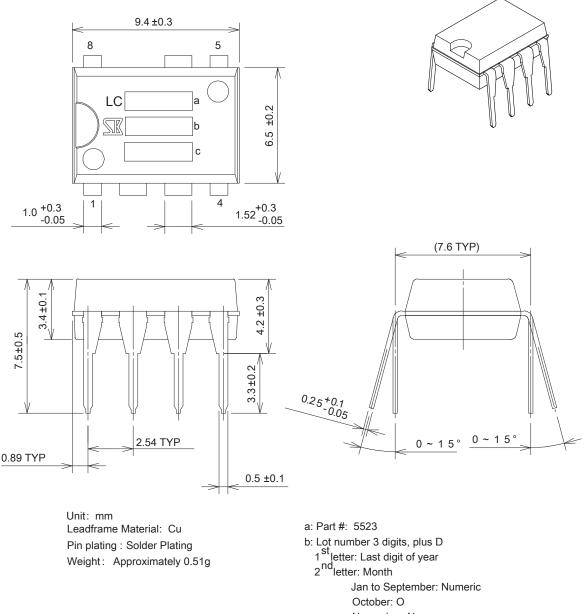








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Package Outline Drawing, DIP8



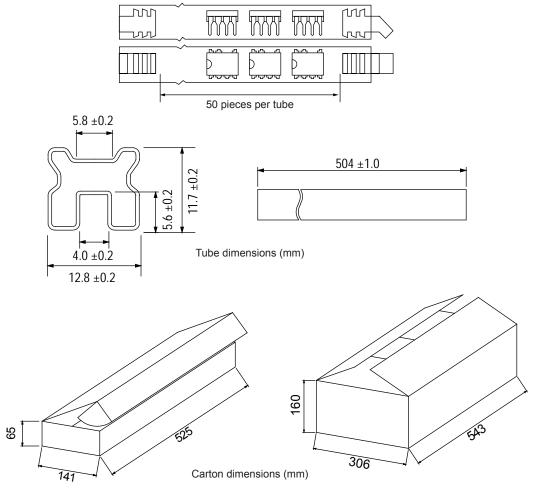
Leadframe plating Pb-free. Device composition compliant with the RoHS directive.

a: Part #: 5523 b: Lot number 3 digits, plus D 1stletter: Last digit of year 2ndletter: Month Jan to September: Numeric October: O November: N December: D 3rdletter: Week Date 1 to 10: 1 Date 11 to 20: 2 Date 21 to 31: 3 c: Internal use control number





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Packing Specifications

50 tubes per inner carton (maximum) 2500 pieces maximum per inner carton

4 inner cartons per outer carton (maximum) 10,000 pieces maximum per outer carton





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Because reliability can be affected adversely by improper storage environments and handling methods, please observe the following cautions.

Cautions for Storage

- Ensure that storage conditions comply with the standard temperature (5°C to 35°C) and the standard relative humidity (around 40% to 75%); avoid storage locations that experience extreme changes in temperature or humidity.
- Avoid locations where dust or harmful gases are present and avoid direct sunlight.
- Reinspect for rust on leads and solderability of products that have been stored for a long time.

Cautions for Testing and Handling

When tests are carried out during inspection testing and other standard test periods, protect the products from power surges from the testing device, shorts between the product pins, and wrong connections.

Remarks About Using Silicone Grease with a Heatsink

- When silicone grease is used in mounting this product on a heatsink, it shall be applied evenly and thinly. If more silicone grease than required is applied, it may produce excess stress.
- Volatile-type silicone greases may crack after long periods of time, resulting in reduced heat radiation effect. Silicone grease with low consistency (hard grease) may cause cracks in the mold resin when screwing the product to a heatsink.
- Our recommended silicone greases for heat radiation purposes, which will not cause any adverse effect on the product life, are indicated below:

Туре	Suppliers
G746	Shin-Etsu Chemical Co., Ltd.
YG6260	Momentive Performance Materials Holding, Inc.
SC102	Dow Corning Toray Co., Ltd.

Soldering

- When soldering the products, please be sure to minimize the working time, within the following limits: 260±5°C 10 s
 - 350±5°C 3 s (solder iron)
- Soldering iron should be at a distance of at least 1.5 mm from the body of the products

Electrostatic Discharge

- When handling the products, the operator must be grounded. Grounded wrist straps worn should have at least 1 M Ω of resistance from the operator to ground to prevent shock hazard, and it should be placed near the operator.
- Workbenches where the products are handled should be grounded and be provided with conductive table and floor mats.
- When using measuring equipment such as a curve tracer, the equipment should be grounded.
- When soldering the products, the head of soldering irons or the solder bath must be grounded in other to prevent leak voltages generated by them from being applied to the products.
- The products should always be stored and transported in Sanken shipping containers or conductive containers, or be wrapped in aluminum foil.





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